DEPARTMENT OF MECHANICAL ENGINEERING

THAPAR INSTITUTE OF ENGINEERING AND TECHNOLOGY, PATIALA-147004

Date: May 15, 2023

Advertisement for the Post of Junior Research Fellow (JRF)

Applications are invited for the post of JRF to work for the SERB-CRG funded research project in the Mechanical Engineering Department at Thapar Institute of Engineering and Technology, Patiala. The details of the project and post for recruitment are given below:

Project Details:

Title of the Project	Investigation of nonlinear dynamics of electrostatically actuated bistable micro switches with applications to medical equipment
Project Duration	03 Years
Name of the Principal	Dr Rajendra Kumar,
Investigator with email	Assistant Professor
and address	Mechanical Engineering Department
	Thapar Institute of Engineering & Technology Patiala-147004
	Email: rajendra.kumar@thapar.edu

Details of the Post:

Name of Post:	Junior Research Fellow (JRF)			
Number of Posts:	One (01)			
Monthly Emolument:	(a) 31,000/- + HRA (for the first two years) and 35,000/- + HRA (for the third year) for GATE qualified candidates (b) 28000/- + HRA for others			
Eligibility Criteria:	Essential: B.E/B.Tech.in Mechanical Engineering/Applied Mechanics/Aerospace Engineering or equivalent degree with at least 60% marks in the aggregate or equivalent C.G.P.A. in the qualifying degree with a valid GATE score. Desirable Qualifications (i) Post-Graduate (M.E./M.Tech.) with specialization in Robotics/CAD-CAM Engg/ Mechatronics/Machine Design/Biomedical Engg./Electronics/Instrumentation and other relevant areas, with marks not below 60% in the aggregate or equivalent C.G.P.A. in the qualifying degree. (ii) Good research potential in the related area in the form of demonstrative research projects/ thesis. The candidate must have good knowledge of mathematical software computer programming language, finite element analysis, and MATLAB.			

Other Details:

How to apply	The candidates are requested to mail the soft copy of the filled-up application
	form (Annexure-I) to "rajendra.kumar@thapar.edu" with the subject of

	the email marked as "Application for JRF under SERB-CRG" on or before
	May 31, 2023.
Other conditions	No TA/DA will be paid for appearing in the interview and/or joining the post.
	All terms and conditions for this recruitment will be as per the guidelines of
	the sponsoring agency and TIET, Patiala.
Call for interview	Shortlisted candidates will be intimated through e-mail for an interview.
	Candidates are advised to check their emails regularly.
Benefits	The selected candidate can register for the full-time PhD program in the
	Mechanical Engineering Department, TIET, Patiala, as per the rules and
	regulations of the institute.
Institute right	The Institute reserves the right to cancel the recruitment without assigning
	any reason.

For any further information/clarifications, the applicants may contact PI by email.

Dr Rajendra Kumar (Principal Investigator) Assistant Professor, Mechanical Engineering Department Email: rajendra.kumar@thapar.edu

Annexure-I (Application Form)

THAPAR INSTITUTE OF ENGINEERING & TECHNOLOGY, PATIALA (Declared as Deemed-to-be University u/s 3 of UGC Act)

1) Ap	ppiication for the post (01:			
2) Name of the Candidate in full (in capital letters):					Insert Your Recer Photograph Here
3) Da					
4) Ag					
5) Contact Information:					
	• Postal Addre	SS:			
• Email:					
6) Na	ationality:				
7) M	arital Status:				
8) Ed	lucational Qualification	1			
Sr.	Name of Exam	Subjects/ Branch/	Name of the	Month &	Percentage of
No	passed	Specializations	University/	Year of	Marks secured/
			Board	exam	CGPA
1				passed	

- 8) Particulars of GATE examination:
 - (i) Year of passing:

Matriculation

Higher

Other

Secondary

B. E./B. Tech

M.E./M.Tech

1

2

3

4

5

(ii) Discipline:

(iii) Score (percentile):
(iv) All India Rank:
(v) The number of candidates appeared:
9) Give contact details of two referees who are familiar with the candidate's work:
10) Any other relevant information which the candidate wishes to furnish:
Declaration
I declare that the above information is true and correct to the best of my knowledge and belief.
Date:
Place: Signature of the applicant